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**Part Number:** [0901361103](#)  
**Status:** **Active**  
**Overview:** C-Grid III™  
**Description:** C-Grid III™ Header, Single Row, Vertical, Shrouded, 3 Circuits, 4µm Tin/Lead (Sn) over Nickel (Ni)

**Documents:**

[3D Model](#) [RoHS Certificate of Compliance \(PDF\)](#)  
[Drawing \(PDF\)](#)

**Agency Certification**

UL E29179

**General**

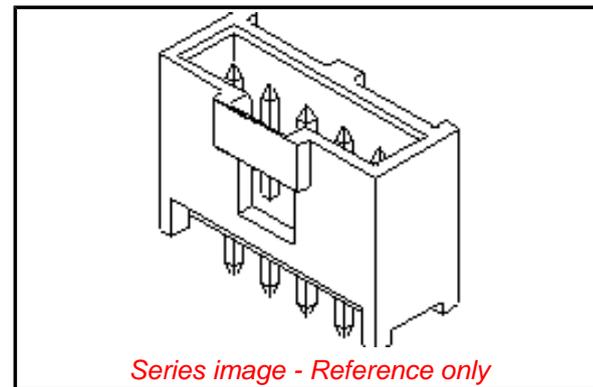
Product Family PCB Headers  
 Series [90136](#)  
 Application Signal, Wire-to-Board  
 Overview [C-Grid III™](#)  
 Product Name C-Grid III™  
 UPC 800753532144

**Physical**

Breakaway No  
 Circuits (Loaded) 3  
 Circuits (maximum) 3  
 Color - Resin Black  
 First Mate / Last Break No  
 Flammability 94V-0  
 Glow-Wire Compliant No  
 Guide to Mating Part No  
 Keying to Mating Part None  
 Lock to Mating Part Yes  
 Material - Metal Brass  
 Material - Plating Mating Tin  
 Material - Plating Termination Tin  
 Material - Resin Polyester  
 Net Weight 0.634/g  
 Number of Rows 1  
 Orientation Vertical  
 PC Tail Length 2.90mm  
 PCB Locator No  
 PCB Retention None  
 PCB Thickness - Recommended 1.60mm  
 Packaging Type Tray  
 Pitch - Mating Interface 2.54mm  
 Pitch - Termination Interface 2.54mm  
 Plating min - Mating 3.048µm  
 Plating min - Termination 3.048µm  
 Polarized to PCB No  
 Shrouded Fully  
 Stackable No  
 Temperature Range - Operating -55°C to +125°C  
 Termination Interface: Style Through Hole

**Electrical**

Current - Maximum per Contact 3.0A  
 Voltage - Maximum 350V AC/DC



**EU ELV**

**Not Relevant**

**EU RoHS**

**Compliant**

**REACH SVHC**

Not Contained Per  
 -ED/79/2015 (17  
 December 2015)

**Halogen-Free**

**Status**

**Not Low-Halogen**

**Need more information on product  
 environmental compliance?**

Email [productcompliance@molex.com](mailto:productcompliance@molex.com)  
 Please visit the [Contact Us](#) section for any  
 non-product compliance questions.

China ROHS

ELV

Green Image

Not Relevant

**Search Parts in this Series**

[90136 Series](#)

**Mates With**

[90123 C-Grid III™ Modular Crimp Housing](#),  
[90156 C-Grid III™ Crimp Housing](#)

**Solder Process Data**

Duration at Max. Process Temperature (seconds)	003
Lead-free Process Capability	WAVE
Max. Cycles at Max. Process Temperature	001
Process Temperature max. C	235

**Material Info**

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